

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT6381258

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
PHI HUNG DOAN	10/16/2020
HOANG DUONG DO	10/16/2020
TIEN DONG NGUYEN	10/16/2020
RECEIVING PARTY DATA	
Name:	VIETTEL GROUP
Street Address:	LOT D26, CAU GIAY NEW URBAN AREA, YEN HOA WARD, CAU GIAY DISTRICT
City:	HA NOI CITY
State/Country:	VIETNAM
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17087535
CORRESPONDENCE DATA	
Fax Number:	(503)224-7017
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Correspondent Name:	PATENTTM.US JAMES H. WALTERS
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ATTORNEY DOCKET NUMBER:	N-236 (20CMNCM)
NAME OF SUBMITTER:	JAMES H WALTERS
SIGNATURE:	/james h walters #35731/
DATE SIGNED:	11/02/2020
Total Attachments: 3	
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source=n236-20201102-Assignment#page3.tif	

Attorney's Docket No.

ASSIGNMENT

WHEREAS, I/We:

1. DOAN, PHI HUNG

Address: Room 916, 24T3 Building, Thanh Xuan Complex Apartment, No. 6 Le Van Thiem, Thanh Xuan Trung Ward, Thanh Xuan District, Ha Noi City, Viet Nam.

2. DO, HOANG DUONG

Address: No. 91, Alley 151, Lang Ha Street, Lang Ha Ward, Dong Da District, Ha Noi City, Viet Nam.

3. NGUYEN, TIEN DONG

Address: No. 28, Alley 38, Thanh Binh Street, Mo Lao Ward, Ha Dong District, Ha Noi City, Viet Nam.

Hereinafter "INVENTOR" am/are inventor/co-inventors of an improvement in a **Weighted load balancing method on data access nodes** for which I/we am/are about to make U.S. patent application; and

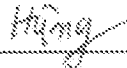
WHEREAS, **VIETTEL GROUP**, hereinafter "ASSIGNEE" a **GROUP** organized under the laws of **VIET NAM** having a place of business at **Lot D26, Cau Giay New Urban Area, Yen Hoa Ward, Cau Giay District, Ha Noi City, Viet Nam** is desirous of acquiring an interest therein;

NOW, THEREFORE, in consideration of One Dollar-(\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, I/We INVENTOR assign and transfer to ASSIGNEE, my/our entire legal and equitable right, title, and interest for the territory of the United States of America, in and to the invention described and claimed in the applications; said inventions, applications, and Letters Patent in the United States of America, and all divisions, continuations, reissues, and extensions thereof, and including the right of priority, to be held and enjoyed by the said ASSIGNEE for its own use and behalf, and for its successors



and assigns, to the full end of the term for which Letters Patent may be granted in the United States of America, as fully and entirely as the same would have been held by us had this assignment and sale not been made, and I/we covenant that I/we have full right to do so, and agree that I/we shall communicate to the said ASSIGNEE, or its successors and assigns any facts known to me/us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful declarations, and generally do everything possible to aid ASSIGNEE, its successors and assigns, to obtain and enforce proper patent protection for said invention in this or any foreign country.

Executed at Ha Noi City, Viet Nam (location), this date: October 16th, 2020, by:



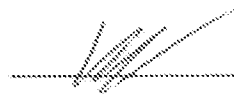
DOAN, PHI HUNG

Executed at Ha Noi City, Viet Nam (location), this date: October 16th, 2020, by:



DO, HOANG DUONG

Executed at Ha Noi City, Viet Nam (location), this date: October 16th, 2020, by:

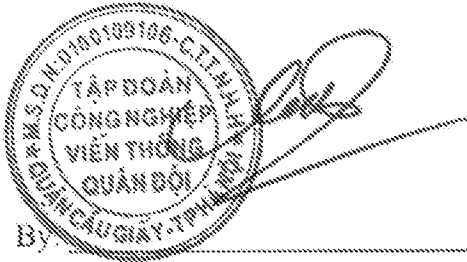


NGUYEN, TIEN DONG

ACCEPTANCE OF ASSIGNMENT

In testimony whereof, the ASSIGNEE hereto has executed this
Assignment on this 2nd of October, 2020.

VIETTEL GROUP



By _____

Signature

Name of Signor: **Le Dang Dzung**

Title of Signor: **Managing Director**

Date: **21/10/2020**

